Infrared dielectric properties of low-stress silicon nitride

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Silicon nitride thin films play an important role in the realization of sensors, filters, and high-performance circuits. Estimates of the dielectric function in the far- and mid-IR regime are derived from the observed transmittance spectra for a commonly employed low-stress silicon nitride formulation. The experimental, modeling, and numerical methods used to extract the dielectric parameters with an accuracy of approximately 4% are presented. © 2012 Optical Society of America

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The physical properties of silicon nitride thin films, namely low tensile stress, low thermal/electrical conductance, and its overall compatibility with other common materials, have facilitated its use in the microfabrication of structures requiring mechanical support, thermal isolation, and low-loss microwave signal propagation (e.g., [1–4]). Silicon nitride films are amorphous, highly absorbing in the mid-IR [5], and their general properties are functions of composition [6,7]. Here the optical properties are studied in detail for a membrane with parameters commonly employed in microfabrication.

The silicon nitride optical test films were prepared by a low-pressure chemical-vapor-deposition (LP-CVD) process optimized for low tensile stress and refractive index [8]. The 5:1 SiHxCl3/NH3 gas ratio employed results in a tensile stress <100 MPa and optical index greater than ~2 [9]. The test structure is shown schematically in Fig. 1 (inset). Double-side-polished silicon (75 mm diameter, 500 μm thick) wafers [10] were used as a mechanically robust handling structure for the SiNₓ membranes. A 150 nm thermal oxide was grown on the silicon wafers by wet oxidation at 950°C for 31 min. This layer was subsequently used as an etch stop to protect the nitride during definition of the silicon handling wafer geometry. A low-stress SiNₓ layer was then deposited by LP-CVD [e.g., deposition parameters for 2 μm film are 835°C for 9.7 h with pressure 33 Pa and 12 sccm NH3, 59 sccm SiH4:Cl2 (SCCM denotes cubic centimeters per minute at standard temperature and pressure)]. The wafers were then patterned with a resist mask and SiNₓ/SiO2 windows formed by deep reactive ion etching, which removed all the silicon under the window area. The residual thermal oxide was removed with hydrogen fluoride vapor etch, leaving a set of uniform SiNₓ membranes each with a 10 mm diameter aperture individually suspended from the silicon handling frame.

The optical tests were performed on SiNₓ samples having membrane thicknesses of 0.5 and 2.3 μm with an uncertainty of 3%. Fabry–Perot resonators were made by stacking multiple samples with silicon standoff frames between adjacent samples to explore the long-wavelength response of the material in greater detail. The silicon standoffs allowed a vent path for evacuation of air between the nitride membranes. All optical measurements were performed in vacuum with a residual pressure less than 100 Pa.

The samples were characterized with a Bruker 125 high-resolution Fourier transform spectrometer (FTS) and were measured in transmission at the focal plane of an f/6 beam. A number of different sources, beam splitters, and detector configurations were used in combination to provide measurements over the reported spectral range. The single-layer SiNₓ sample transmission was measured over an extended range from 15 to 10,000 cm⁻¹. The mercury lamp and a multilayer Mylar beam splitter were used to access frequencies below 600 cm⁻¹. Additional mid-IR spectral data up to 2400 cm⁻¹ were acquired using a ceramic glow bar source, Ge-coated KBr beam splitter, and room-temperature deuterated tri-glycine sulfate detector. The remaining near-IR data up to 10,000 cm⁻¹ were taken with a W filament source, Si on CaF2 beam splitter, and a liquid-nitrogen-cooled InSb detector (Fig. 1). Far-IR data between 15 and 95 cm⁻¹ were taken using a mercury arc filament source.

Fig. 1. (Color online) Room-temperature transmission of a silicon nitride sample 0.5 μm thick: measured (grey), model (black dotted), and residual (red). The shaded band’s width defines the estimated 3σ measurement uncertainty. A 30 GHz (1 cm⁻¹) resolution is employed for the measurement. The insert depicts the geometry of the SiNₓ membrane and micromachined silicon frame.

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lack of significant phase error between the modeled and measured results. The data shown in Fig. 1 was modeled with a Drude dispersion model [11], 

\[
\hat{\varepsilon}_r(\omega) = \hat{\varepsilon}_\infty + \sum_{j=1}^{M} \frac{\Delta \varepsilon_j \cdot \omega^2}{\omega^2_r - \omega^2 - i\omega \Gamma_j(\omega)},
\]

where \(M\) is the number of oscillators and \(\hat{\varepsilon}_r = \varepsilon'_r + i\varepsilon''_r\) is a complex function of \((5M + 2)\) degrees of freedom, which are as follows: the contribution to the relative permittivity \(\hat{\varepsilon}_\infty = \hat{\varepsilon}_{M+1}\) of higher lying transitions, the difference in relative complex dielectric constant between adjacent oscillators \(\Delta \varepsilon_j = \varepsilon_j - \varepsilon_{j+1}\), which serves as a measure of the oscillator strength, the oscillator resonance frequency \(\omega_{T_j}\), and the effective Lorentzian damping coefficient \(\Gamma_j(\omega)\) for \(j = 1, \ldots, M\). The following functional form is used to specify the damping:

\[
\Gamma_j(\omega) = \Gamma_j \exp \left[ -\alpha_j \left( \frac{\omega^2_{T_j} - \omega^2}{\omega^2_{T_j}} \right)^2 \right],
\]

where \(\alpha_j\) allows interpolation between Lorentzian (\(\alpha_j = 0\)) and Gaussian wings (\(\alpha_j > 0\)) similar to the approach in [12]. The form indicated above enables a more accurate representation of relatively strong oscillator features.

The impedance contrast between free space and the thin-film sample forms a Fabry–Perot resonator. The observed transmission can be modeled [13] as a function of the dielectric response [Eq. (1)], thickness, and wavenumber. The dielectric parameters were solved by means of a nonlinear least-squares fit of the transmission equation to the laboratory FTS data. Specifically, a sequential quadratic programming method with computation of the Jacobian and Hessian matrices [14,15] was implemented. The merit function, \(\chi^2\), was used in a constrained minimization over frequency as follows:

\[
\min_{\text{DOF}} \chi^2 = \min_{\text{DOF}} \sum_{k=1}^{N} \left[ T(\hat{\varepsilon}_r(\omega)), h - T_{\text{FTS}}(\omega) \right]^2,
\]

where \(N\) is the number of data points, \(T\) the modeled transmittance, \(T_{\text{FTS}}\) the measured transmittance data, and \(h\) the measured sample thickness. We are guided by the Kramers–Kronig relations in defining constraints for a passive material: \(|\varepsilon_j| > |\varepsilon_{j+1}|\), \(\varepsilon'_j > 0\) and \(\varepsilon_r(0) = \varepsilon_1\) [16]. For accurate parameter determination, the sample should have uniform thickness, be adequately transparent to achieve high signal to noise, and have diffuse scattering as a subdominate process. The method requires an a posteriori numerical verification for Kramers–Kronig consistency. In the example presented here, a numerical Hilbert transform [17] of \(\varepsilon'_r(\omega)\) reproduces \(\varepsilon''_r(\omega)\) to within 2% (Fig. 3). An alternative method employing reflectivity and phase allows a priori Kramers–Kronig consistent results [18]. However, given the details of the thin-film samples and available instrumentation, this approach was not implemented.

Figure 1 illustrates the measured and modeled results obtained from the analysis of a 0.5 \(\mu\)m thick sample. The peak residual in the transmittance is less than 3%, and the 3\(\sigma\) = 0.023 uncertainty band indicated corresponds to the 99.7% confidence level. The standard deviation adopted for the measured data, \(\sigma\), was estimated assuming the errors as a function of frequency were uniform and had a reduced \(\chi^2\) equal to unity. An additional

![Fig. 2. Measured (solid grey) and model (black dotted) transmission for a three-layer stack of silicon nitride samples 2.3 \(\mu\)m in thickness with 998 \(\mu\)m intermembrane delays that complements the data shown in Fig. 1. The sample response in the far-IR was acquired with a resolution of 3 GHz (0.1 cm\(^{-1}\)).](image-url)
uncertainty in the FTS normalization influences the dielectric response function at the 1% level. In addition to the channel spectra, the observed spectrum shows two predominant features at 12 and 25 THz. Simulations with $M = 2$ oscillators lead to a peak residual on transmission of 5% and do not enable recovery of the resonance at 25 THz. Using five oscillators satisfactorily recovers the observed transmittance and reduces the resonance at 25 THz. Using five oscillators satisfactorily recovers the observed transmittance and reduces the mission residuals were decreased by a factor of 4.4. When the resonator or Eq. (4.6) in [12]. In these regions, the peak transmission residuals were decreased by a factor $\sim 2$ through the use of Eq. (2).

In Fig. 2 the values of the real and imaginary components of the dielectric function are illustrated as a function of frequency. The uncertainty in $\hat{\epsilon}_r$ was propagated and computed as described in [19]. Table 1 contains a summary of the best fit parameters for five oscillators, which can be used to reproduce the data shown in Fig. 3.

To characterize the long-wavelength portion of the dielectric function, Fabry–Perot resonators were realized from one-, two-, and three-layer samples. Representative data for the three-layer resonator stack are presented in Fig. 2. A multilayer transfer matrix analysis [13] is used to extract the dielectric function using the measured SiN$_x$ (2.3 μm) and silicon spacer (998 μm) thicknesses. The circular symbols at 1.5 and 2.5 THz indicated in Fig. 3 were computed from a composite analysis of the three Fabry–Perot measurement sets. The horizontal range indicates the data used in each fit. The best estimates are $\hat{\epsilon}_r \approx 7.6 + i 0.08$ over the range of 2–3 THz and $\hat{\epsilon}_r \approx 7.6 + i 0.04$ over 0.4–2 THz. The real component of the static dielectric function derived from the data is in agreement with prior reported parameters for this stoichiometry [4]. As shown in Fig. 3, the measurements are internally consistent and represent roughly a factor-of-three reduction in uncertainty relative to prior IR SiN$_x$ measurements identified by the authors [5–7]. The dielectric parameters reported here are representative of low-stress SiN$_x$ membranes encountered in our fabrication and test efforts.

References and notes

10. Addison Engineering, 150 Nortech Parkway, San Jose, California 95134 (Orientation (100), Czochralski, p-type B doped, bulk resistivity < 0.005 Ω cm).

Table 1. Fit Parameter Summary

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